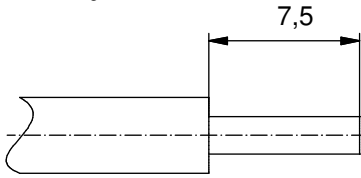


Stripping Dimensions/
Kabelvorbereitung:



Materials/

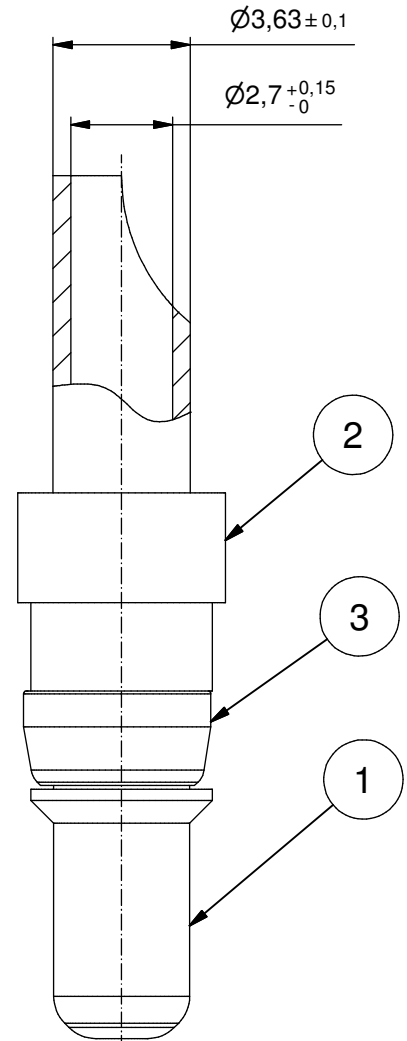
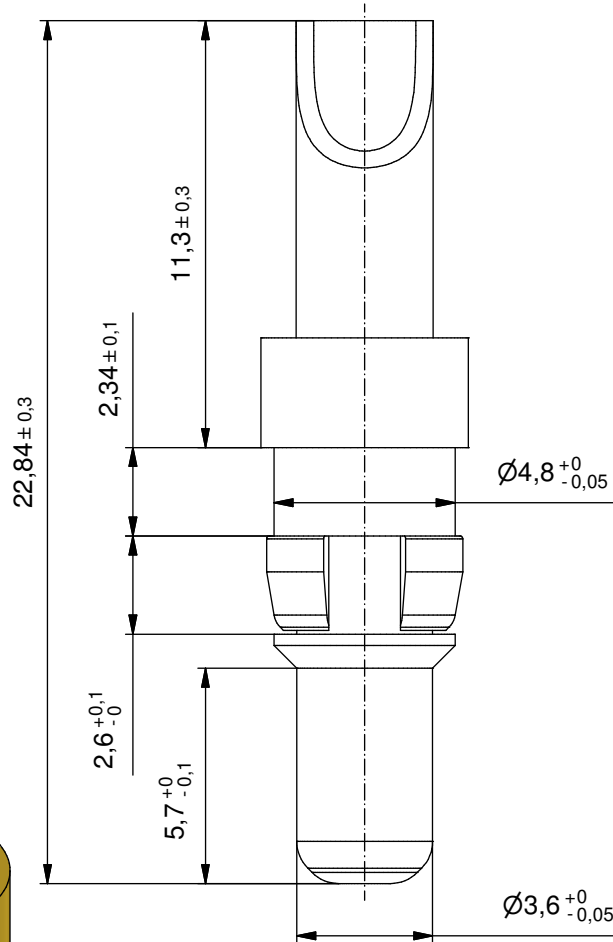
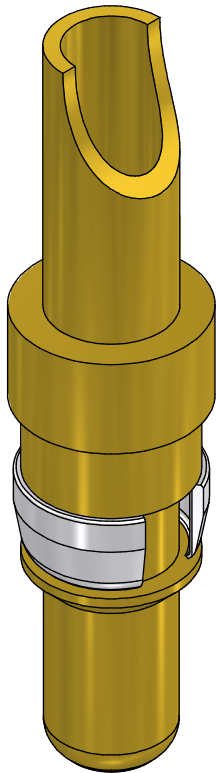
Werkstoffe:

Cu alloy, Au over Ni

Contact/
Kontakt:

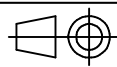
Retaining ring/
Haltering:

Cu alloy, Ni



(b)

Part no. / Art.-Nr.:	Plating Pos. 1/ Veredelung Pos. 1:	Plating Pos. 2/ Veredelung Pos. 2:	Plating Pos. 3/ Veredelung Pos. 3:
131A10029X	Gold Flash over Nickel Gold über Nickel	Gold over Nickel Gold über Nickel	Nickel plated/ vernickelt
131C10029X	min. 30 µm hard Gold over min. 50 µm Nickel min. 30 µm Gold über min. 50 µm Nickel	Gold over Nickel Gold über Nickel	Nickel plated/ vernickelt
131J10029X	min. 50 µm hard Gold over min. 50 µm Nickel min. 50 µm Gold über min. 50 µm Nickel	Gold over Nickel Gold über Nickel	Nickel plated/ vernickelt



dim. in mm

High power contact male
Solder cup 20 A for AWG 12-14

Hochstromkontaktstift
Lötkelch 20 A für AWG 12-14

general tolerance/
Allgemeintoleranz:

ISO 2768-m

	Date/Datum	Name
drawn/ gez.	17.08.16	Henneboel
appd./ gepr.	17.08.16	Koch

Index: b Ä6278 17.08.16 K.H.

scale/Maßstab:

5:1



dwg no /
Z.-nr.:

13K1A5266

DIN-
A4

RoHS & REACH compliant/konform

1 / 1

Mouser Electronics

Authorized Distributor

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